ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	ials and Mfg Information				
upplier Inform	ation														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
nsemi												2024-05-21			
Contact Name		Title - Contact				Phone - Contact*					Email - Contact*				
Product-Env-Stewa	rds		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
uthorized Represe	ntative*		Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewa	rds		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Requeste	r Item Number	Mfr Item Number		Mfr Item Name		·	Effective Da	te Ve	e Version Manufacturing Site		ng Site	V	Veight*	UOM	Unit Type
		NCV8135 BG	NCV8135AMTW075T 500 mA, Very Lo BG CMOS Voltage R		w Dropout Bia egulator Wet	s Rail flanks	2024-05-21	21 MY1			9	.47	mg	Each	
Ianufacturing l	Proccess Information	n													
Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperature Max Time at Pe		ne at Peak	k Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed		CU	CU Alloy 1		1		260	260 C		30 seco		second	ds 3		
omments															
vel 1 - maximum ti	ime at peak temperature	during sold	lering is 10-3	0 seconds											
or more informatio	on regarding material con	nposition p	lease refer to	page 3									·		

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.48	mg	Supplier	Silicon (Si)	7440-21-3		0.48	mg
Die Attach	0.12	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0072	mg
			Supplier	Silver (Ag)	7440-22-4		0.0978	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0072	mg
			Supplier	Misc.	Proprietary Data		0.0006	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0072	mg
Lead Frame	2.65	mg	Supplier	Tin (Sn)	7440-31-5		0.0066	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0058	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0066	mg
			Supplier	Copper (Cu)	7440-50-8		2.6309	mg
Lead Frame plating	0.05	mg	Supplier	Silver (Ag)	7440-22-4		0.05	mg
Mold Compound-Black	5.47	mg	Supplier	Epoxy resins	129915-35-1		0.2735	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2735	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0219	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1258	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.6495	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.1258	mg
Plating	0.39	mg	Supplier	Tin (Sn)	7440-31-5		0.39	mg
Wire Bond - Au	0.31	mg	Supplier	Gold (Au)	7440-57-5		0.31	mg